

APPROVAL SHEET

RFBLN 1005 (0402) Series - RoHS Compliance

MULTILAYER CERAMIC BALUN TRANSFORMER

Halogens Free Product

2.4 GHz ISM Band RF Application

P/N: RFBLN1005040A67N3T

*Contents in this sheet are subject to change without prior notice.



FEATURES

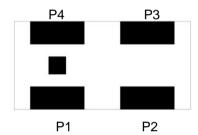
- 1. Miniature footprint: 1.0 X 0.5X 0.4 mm³
- 2. Low Insertion Loss
- 3. Low in-band amplitude and phase imbalance enhances system performance
- 4. LTCC process

APPLICATIONS

- 1. ISM band 2.4GHz working frequency
- 2. Bluetooth, Wireless LAN 802.11b/ g/ n, HomeRF

CONSTRUCTION

Top view



PIN	Connection
1	Unbalanced Port
2	Balanced port
3	Balanced port
4	GND

DIMENSIONS

Figure		Symbol	Dimension (mm)
	_ L	L	1.00 ± 0.10
Top view	■ ■ ■ ■ ■ ■ ■ ■ ■ ■ ■ ■ ■ ■ ■ ■ ■ ■ ■	W	0.50 ± 0.10
	V T	Т	0.40 ± 0.10
Bottom view	ш в в	А	0.10 ± 0.10
		В	0.30 ± 0.10
	A B C Side view	С	0.20 ± 0.10
Side view		D	0.50 ± 0.10
	D	Е	0.125 ± 0.10



ELECTRICAL CHARACTERISTICS

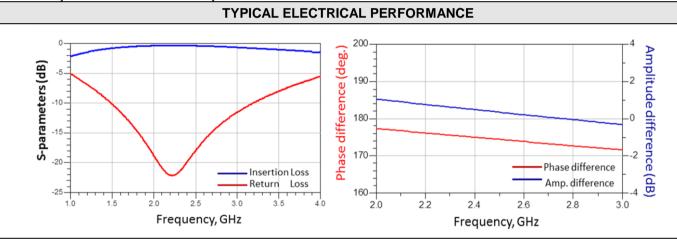
RFBLN1005040A67N3T	Specification
Frequency Range	2400~2500 MHz
Insertion Loss	0.8 dB max.
Phase Difference	180° ± 10°
Amplitude Difference	2.0 dB max.
VSWR	2.0 max.
Unbalanced Impedance	50Ω
Balanced Impedance	50Ω
Power capacity	500 mW max.
Moisture sensitivity levels	MSL is LEVEL 1 (Refer to : IPC/JEDEC J-STD-020)

Operating & Storage Condition (Component)

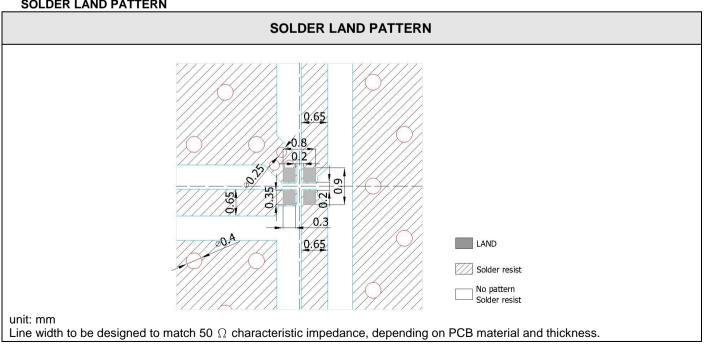
Operation Temperature Range: -40 ~ +85 $^{\circ}$ C Storage Temperature Range: -40 ~ +85 °C

Storage Condition before Soldering (Included packaging material)

Storage Temperature Range: +5 ~ +40 °C Humidity: 30 to 70% relative humidity



SOLDER LAND PATTERN





RELIABILITY TEST

Test item	Test condition / Test method	Specification
Solderability	*Solder bath temperature : 235 \pm 5°C	At least 95% of a surface of each terminal
JIS C 0050-4.6	*Immersion time : 2 ± 0.5 sec	electrode must be covered by fresh solder.
JESD22-B102D	Solder : Sn3Ag0.5Cu for lead-free	
Leaching	*Solder bath temperature: 260 ± 5°C	Loss of metallization on the edges of each
(Resistance to	*Leaching immersion time : 30 ± 0.5 sec	electrode shall not exceed 25%.
dissolution of	Solder : SN63A	
metallization) IEC 60068-2-58		
Resistance to soldering		
heat	*Preheating temperature : 120~150℃,	No mechanical damage.
JIS C 0050-5.4	1 minute.	Electrical specification shall satisfy the
	*Solder temperature: 270±5°C	descriptions in electrical characteristics under
	*Immersion time: 10±1 sec	the operational temperature range within -40
		~ 85°C.
	Solder : Sn3Ag0.5Cu for lead-free	Loss of metallization on the edges of each
	Measurement to be made after keeping at	electrode shall not exceed 25%.
	room temperature for 24±2 hrs	
Drop Test	*Height: 75 cm	No mechanical damage.
JIS C 0044	*Test Surface : Rigid surface of concrete or	Electrical specification shall satisfy the
Customer's specification.	steel.	descriptions in electrical characteristics under
	*Times: 6 surfaces for each units; 2 times	the operational temperature range within -40
	for each side.	~ 85°C.
	ioi each side.	
Vibration	*Frequency: 10Hz~55Hz~10Hz(1min)	No mechanical damage.
JIS C 0040	*Total amplitude: 1.5mm	Electrical specification shall satisfy the
	*Test times : 6hrs.(Two hrs each in three	descriptions in electrical characteristics under
	mutually perpendicular directions)	the operational temperature range within -40
		~ 85°C.
Adhesive Strength	*Pressurizing force :	No remarkable demands as seemed of the
of Termination	5N(≦0603) ; 10N(>0603)	No remarkable damage or removal of the termination.
JIS C 0051- 7.4.3		termination.
Bending test	*Test time: 10±1 sec	
JIS C 0051- 7.4.1	The middle part of substrate shall be	No mechanical damage.
	pressurized by means of the pressurizing rod	Electrical specification shall satisfy the
	at a rate of about 1 mm/s per second until the	descriptions in electrical characteristics under
	deflection becomes 1mm/s and then pressure shall be maintained for 5±1 sec.	the operational temperature range within -40
	Measurement to be made after keeping at	~ 85°C.
	room temperature for 24±2 hours	
	TOOM temperature for 24±2 flours	



Approvar street		
Temperature cycle JIS C 0025	 30±3 minutes at -40°C±3°C, 10~15 minutes at room temperature, 30±3 minutes at +85°C±3°C, 10~15 minutes at room temperature, Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs 	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
High temperature JIS C 0021 Humidity	*Temperature : 85°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
(steady conditions) JIS C 0022	*Humidity: 90% to 95% R.H. *Temperature: 40±2°C *Time: 1000+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs % 500hrs measuring the first data then 1000hrs data	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Low temperature JIS C 0020	*Temperature : -40°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.



SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,

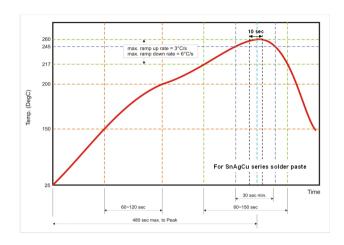


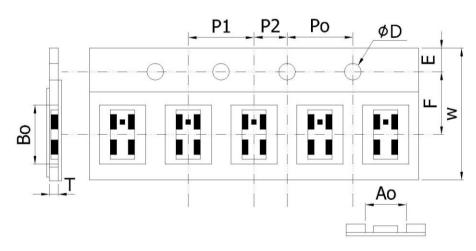
Fig 2. Infrared soldering profile

ORDERING CODE

RF	BLN	100504	0	Α	67N3T
Walsin	Product Code	Dimension code	Unit of	Application	Specification
RF device	BLN : BALUN	Per 2 digits of Length,	dimension	A: 2.4GHz ISM Band	Design Code
		Width, Thickness:	0 : 0.1 mm		
		e.g. :	1 : 1.0 mm		
		100504=			
		Length 10,			
		Width 05,			
		Thickness 04			

Minimum Ordering Quantity: 4000 pcs per reel.

PACKAGING

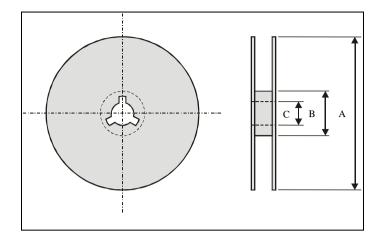


Paper Tape specifications (unit :mm)

Index	Ao	Во	ΦD	Т	W
Dimension (mm)	0.67 ± 0.10	1.14 ± 0.10	1.50 + 0.10	0.42 ± 0.10	8.0 ± 0.30
Index	E	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	3.50 ± 0.20	4.00 ± 0.10	2.00 ± 0.10	2.00 ± 0.10



Reel dimensions



Index	А	В	С
Dimension (mm)	Ф178	Ф60.0	Ф13.5

Taping Quantity: 4000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.

■ Temperature :+5 to +40°C

Humidity : 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.